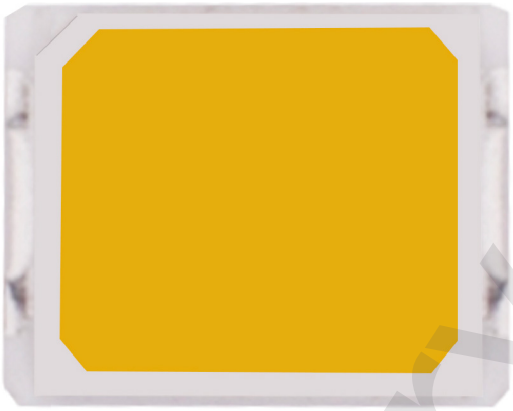


Bridgelux® SMD 2835 1W 6V

Product Data Sheet DS1526

Preliminary

Introduction

SMD 2835



Features

- Industry-standard 2835 footprint
- RoHS compliant and lead free
- Multiple CCT configurations for a wide range of lighting applications

Benefits

- Lower operating and manufacturing cost
- Ease of design and rapid go-to-market
- Uniform, consistent white light
- Reliable and constant white point
- Compliant with environmental standards
- Design flexibility

Preliminary

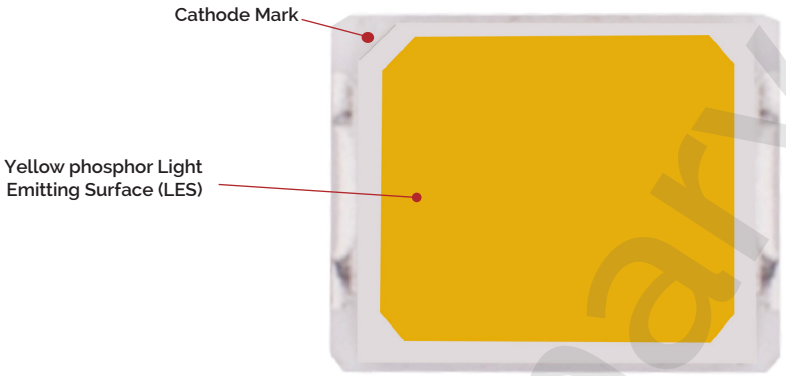
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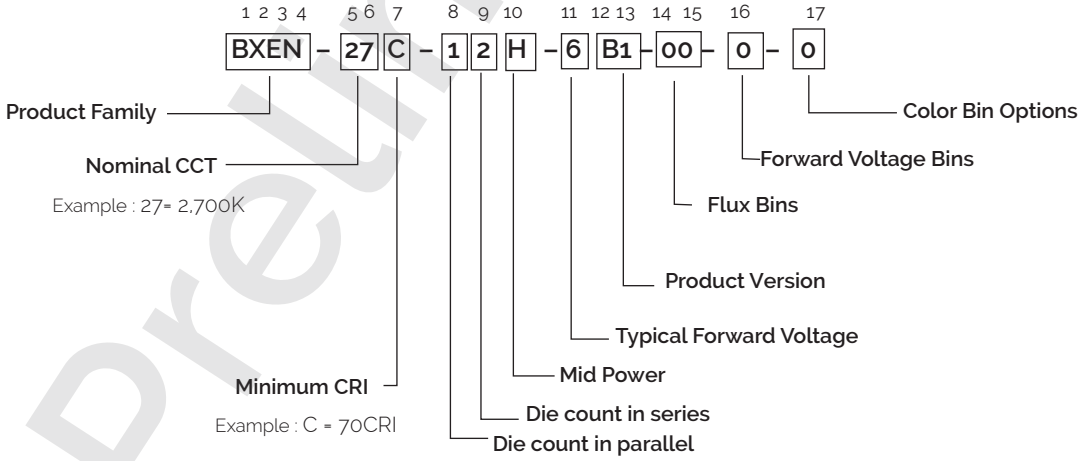
Product Feature Map

Bridgelux SMD LED products come in industry standard package sizes and follow ANSI binning standards. These LEDs are optimized for cost and performance, helping to ensure highly competitive system lumen per dollar performance while addressing the stringent efficacy and reliability standards required for modern lighting applications.



Product Nomenclature

The part number designation for Bridgelux SMD 2835 is explained as follows:



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Product Selection Guide

The following product configurations are available:

Table 1: Selection Guide, Pulsed Measurement Data at 150mA (T_j=T_{sp}=25˚C)

Part Number[1,6]	Nominal CCT[2] (K)	CRI[3, 5]	Nominal Drive Current (mA)	Forward Voltage[4, 5] (V)			Typical Pulsed Flux (lm)[4, 5]	Typical Power (W)	Typical Efficacy (lm/W)
				Min	Typical	Max			
BXEN-27C-12H-6B1-00-0-0	2700	70	150	6.20	6.30	6.40	133	1.0	139
BXEN-65C-12H-6B1-00-0-0	6500	70	150	6.20	6.30	6.40	137	1.0	143
BXEN-68C-12H-6B1-00-0-0	6800	70	150	6.20	6.30	6.40	137	1.0	143

Table 2: Selection Guide, Pulsed Test Performance (T_{sp} = 85˚C)[7,8]

Part Number[1,6]	Nominal CCT[2] (K)	CRI[3, 5]	Nominal Drive Current (mA)	Forward Voltage[4, 5] (V)			Typical Pulsed Flux (lm)[4, 5]	Typical Power (W)	Typical Efficacy (lm/W)
				Min	Typical	Max			
BXEN-27C-12H-6B1-00-0-0	2700	70	150	6.04	6.14	6.24	116	0.9	124
BXEN-65C-12H-6B1-00-0-0	6500	70	150	6.04	6.14	6.24	119	0.9	127
BXEN-68C-12H-6B1-00-0-0	6800	70	150	6.04	6.14	6.24	119	0.9	127

Notes for Tables 1 & 2:

1. The last 6 characters (including hyphens '-') refer to flux bins, forward voltage bins, and color bin options, respectively. "00-0-0" denotes the full distribution of flux, forward voltage, and color bin.
   Example: BXEN-27C-12H-6B1-00-0-0 refers to the full distribution of flux, forward voltage, and color within a 2700K 3-step ANSI standard chromaticity region with a minimum of 70 CRI, 2x1 die configuration, mid power, 6.3V typical forward voltage.
2. Product CCT is cold targeted at Tsp = 25˚C. Nominal CCT as defined by ANSI C78.377-2011.
3. Listed CRIs are minimum values.
4. Products tested under pulsed condition (10ms pulse width) at nominal drive current where Tj=Tsp=25˚C.
5. Bridgelux maintains a ±7.5% tolerance on luminous flux measurements, ±0.1V tolerance on forward voltage measurements, and ±2 tolerance on CRI measurements for the SMD 2835.
6. Refer to Table 5 and Table 6 for Bridgelux SMD 2835 Luminous Flux Binning and Forward Voltage Binning information.
7. Typical pulsed test performance values are provided as reference only and are not a guarantee of performance.
8. Typical performance is estimated based on operation under pulsed current with LED emitter mounted onto a heat sink with thermal interface material and the solder point temperature maintained at 85˚C. Based on Bridgelux test setup, values may vary depending on the thermal design of the luminaire and the exposed environment to which the product is subjected.

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Electrical Characteristics

Table 3: Electrical Characteristics

Part Number	Drive Current (mA)	Forward Voltage (V) [1,2]			Typical Temperature Coefficient of Forward Voltage $\Delta V_f/\Delta T$ (mV/°C)	Typical Thermal Resistance Junction to Solder Point[3] $R_{j\text{-}sp}$ (°C/W)
		Minimum	Typical	Maximum		
BXEN-XXX-12H-6B1-00-0-0	150	6.20	6.30	6.40	-2.68	20

Notes for Table 3:

1. Bridgelux maintains a tolerance of ± 0.1V on forward voltage measurements. Voltage minimum and maximum values at the nominal drive current are guaranteed by 100% test.
2. Products tested under pulsed condition (10ms pulse width) at nominal drive current where Tsp = 25°C.
3. Thermal resistance value was calculated using total electrical input power; optical power was not subtracted from input power.

Preliminary

Absolute Maximum Ratings

Table 4: Maximum Ratings

Parameter	Maximum Rating
LED Junction Temperature (T_j)	125˚C
Storage Temperature	-40˚C to +105˚C
Operating Solder Point Temperature (T_{Sp})	-40˚C to +105˚C
Soldering Temperature	260˚C or lower for a maximum of 10 seconds
Maximum Drive Current	150mA
Maximum Peak Pulsed Forward Current[1]	300mA
Maximum Reverse Voltage[2]	-
Moisture Sensitivity Rating	MSL 3
Electrostatic Discharge	2kV HBM. JEDEC-JS-001-HBM and JEDEC-JS-001-2012

Notes for Table 4:

1. Bridgelux recommends a maximum duty cycle of 10% and pulse width of 10 ms when operating LED SMD at maximum peak pulsed current specified. Maximum peak pulsed current indicate values where LED SMD can be driven without catastrophic failures.
2. Light emitting diodes are not designed to be driven in reverse voltage and will not produce light under this condition. no rating is provided

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Product Bin Definitions

Table 5 lists the standard photometric luminous flux bins for Bridgelux SMD 2835 LEDs. Although several bins are listed, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all CCTs.

Table 5: Luminous flux Bin Definitions at 150mA, T_{sp}=25˚C

Bin Code	Minimum	Maximum	Unit	Condition
5J	130	135	lm	I_F=150mA
5K	135	140		
5L	140	145		
5M	145	150		

Note for Table 5:

1. Bridgelux maintains a tolerance of ± 7.5% on luminous flux measurements.

Table 6: Forward Voltage Bin Definition at 150mA, T_{sp}=25˚C

Bin Code	Minimum	Maximum	Unit	Condition
K	6.2	6.4	V	I_F=150mA

Note for Table 6:

1. Bridgelux maintains a tolerance of ± 0.1V on forward voltage measurements.

Preliminary

Product Bin Definitions

Table 7: MacAdam Ellipse Color Bin Definitions

CCT	Color Space	Center Point		Major Axis	Minor Axis	Ellipse Rotation Angle	Color Bin
		X	Y				
2700K	3 SDCM	0.4625	0.4154	0.0081	0.0042	53.70	1
6500K	3 SDCM	0.3123	0.3310	0.00669	0.00285	58.57	1
6800K	3 SDCM	0.3084	0.3226	0.00669	0.00285	58.57	1

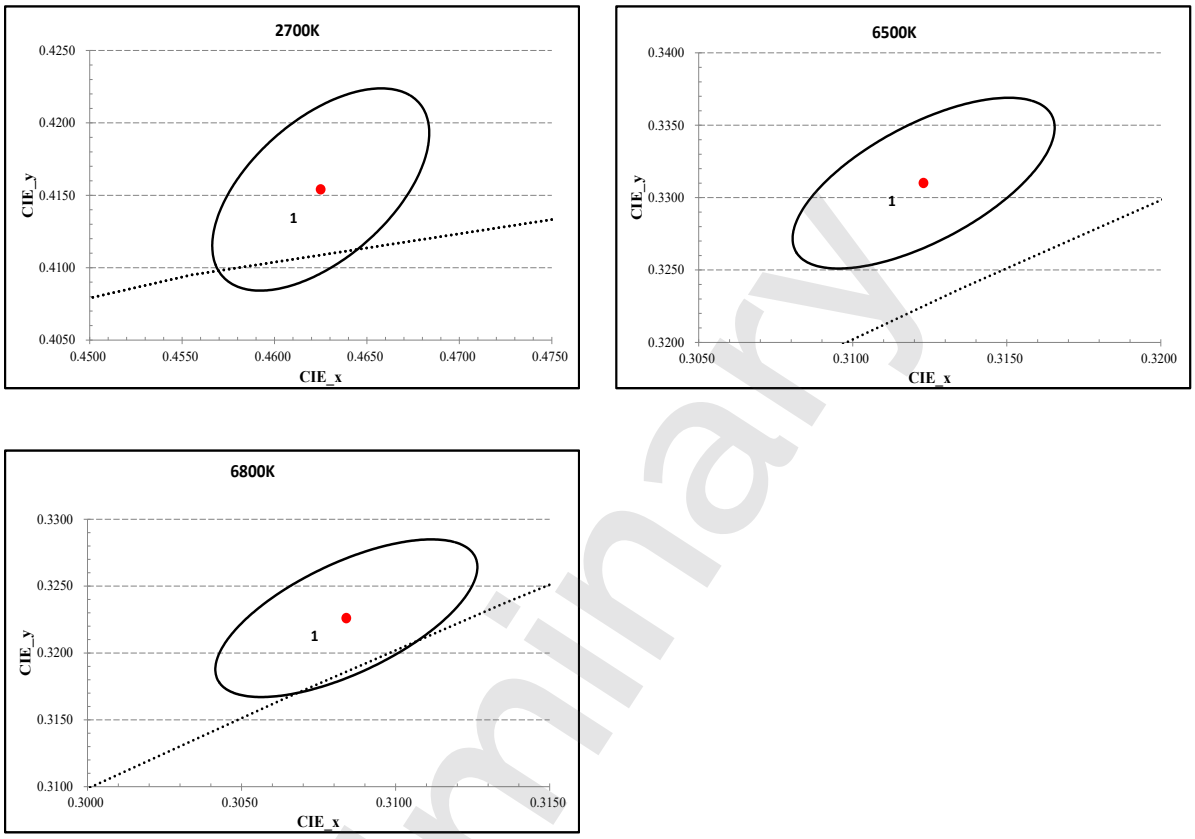
Notes for Table 7:

1. Color binning at T_{sp}=25˚C unless otherwise specified
2. Bridgelux maintains a tolerance of ± 0.007 on x and y color coordinates in the CIE 1931 color space.

Preliminary

Product Bin Definitions

Figure 1: C.I.E. 1931 Chromaticity Diagram (Cold-color Targeted at T_{sp}=25˚C)



Preliminary

Performance Curves

Figure 2: Drive Current vs. Forward Voltage (T_{sp}=25°C)

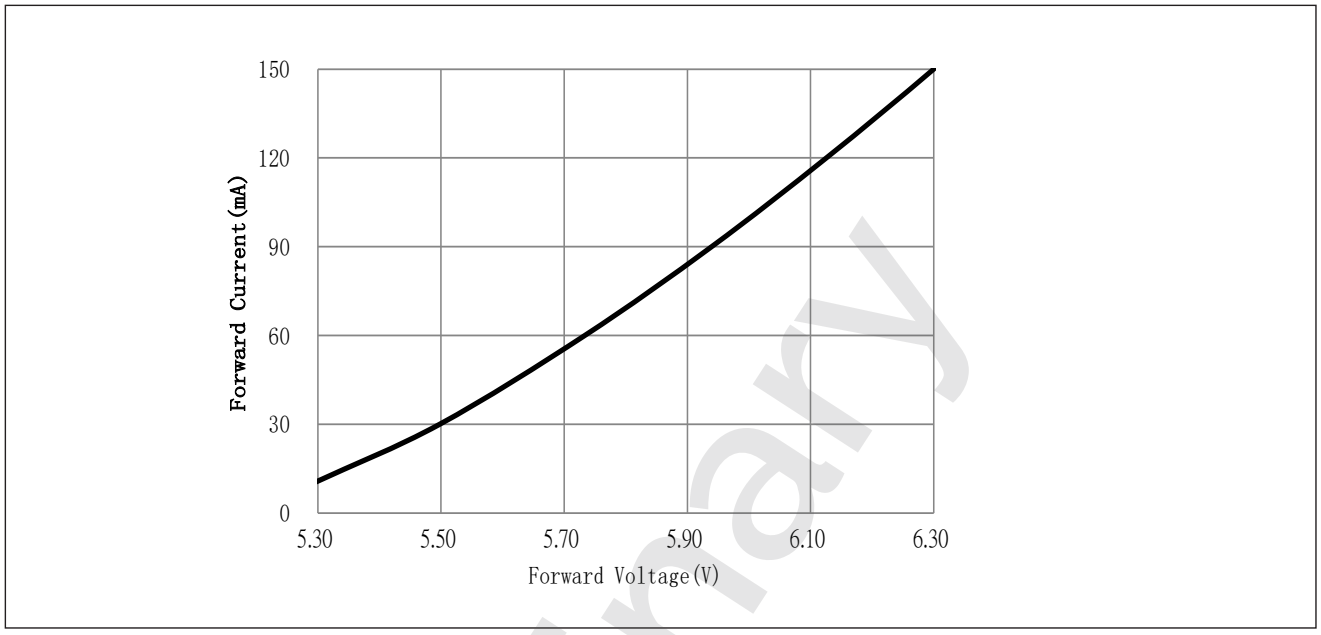
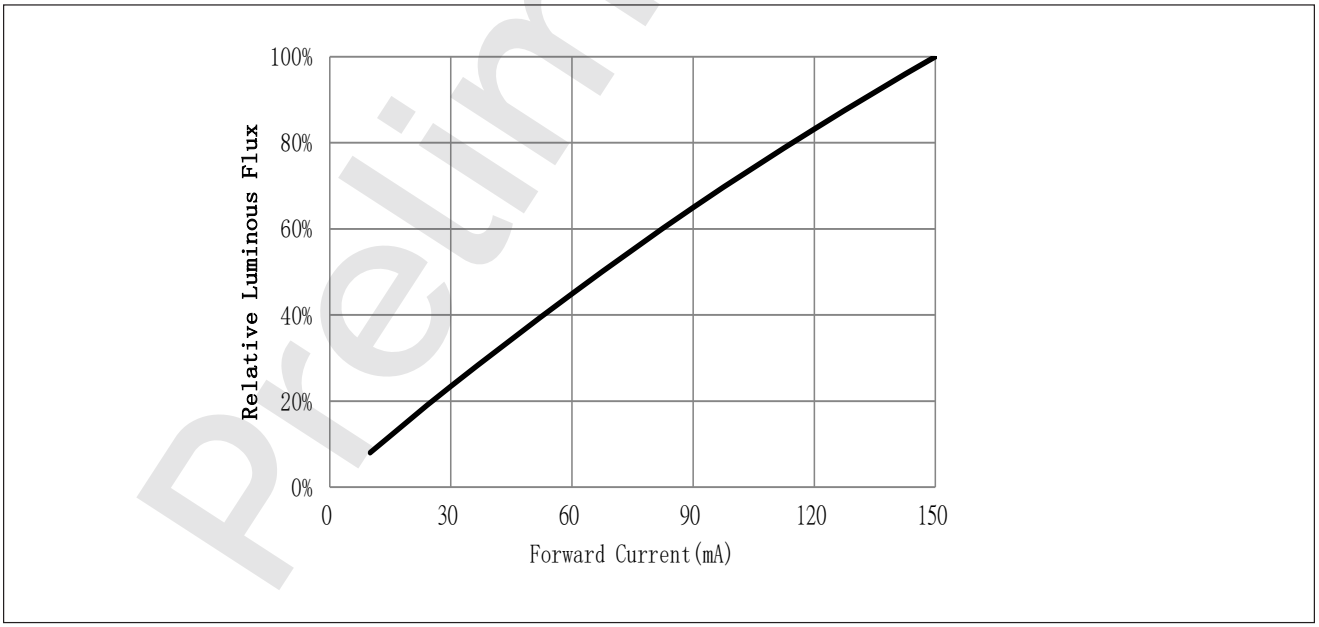


Figure 3: Typical Relative Luminous Flux vs. Forward Current (T_{sp}=25°C)



Note for Figure 3:

1. Pulse width modulation (PWM) is recommended for dimming effects.

Preliminary

Performance Curves

Figure 4: Typical Relative Flux vs. Solder Point Temperature

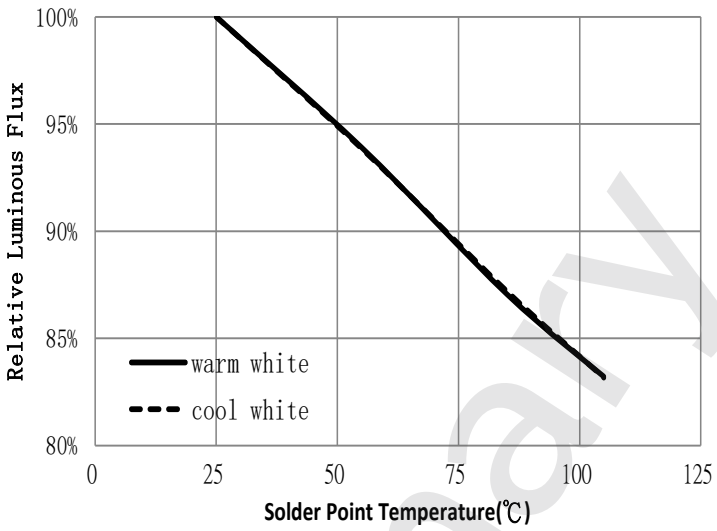
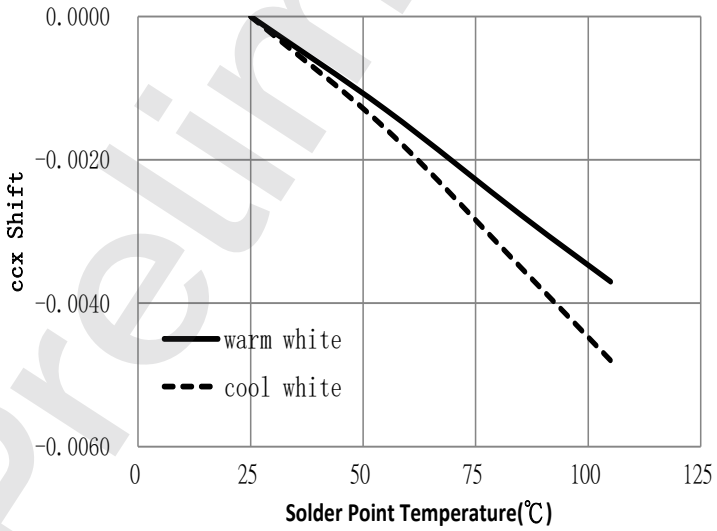


Figure 5: Typical ccx Shift vs. Solder Point Temperature



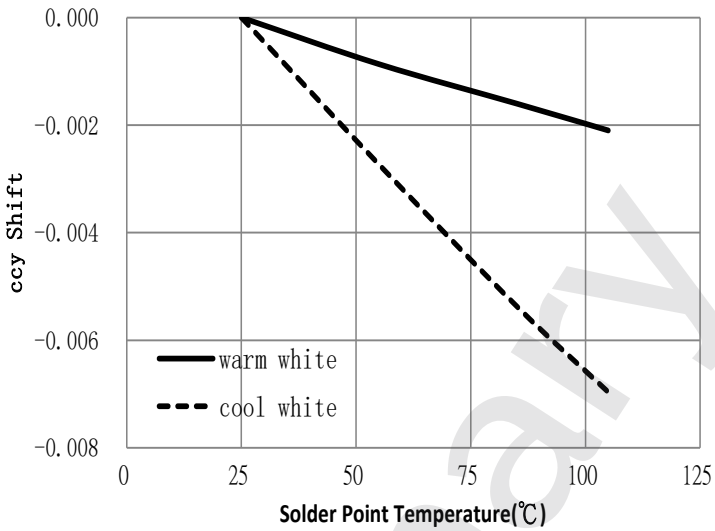
Preliminary

Notes for Figures 4 & 5:

1. Characteristics shown for warm white based on 2700K and 70 CRI.
2. Characteristics shown for cool white based on 6500K and 70 CRI.
3. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

Performance Curves

Figure 6: Typical ccy Shift vs. Solder Point Temperature



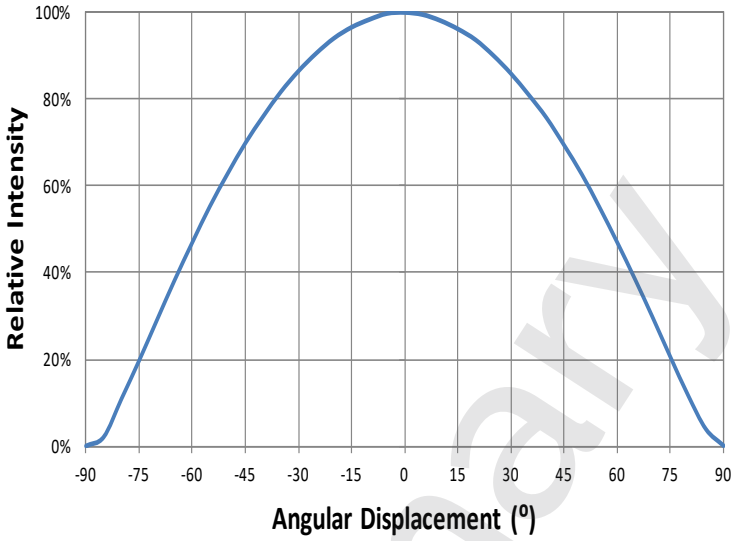
Notes for Figure 6:

1. Characteristics shown for warm white based on 2700K and 70 CRI.
2. Characteristics shown for cool white based on 6500K and 70 CRI.
3. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

Preliminary

Typical Radiation Pattern

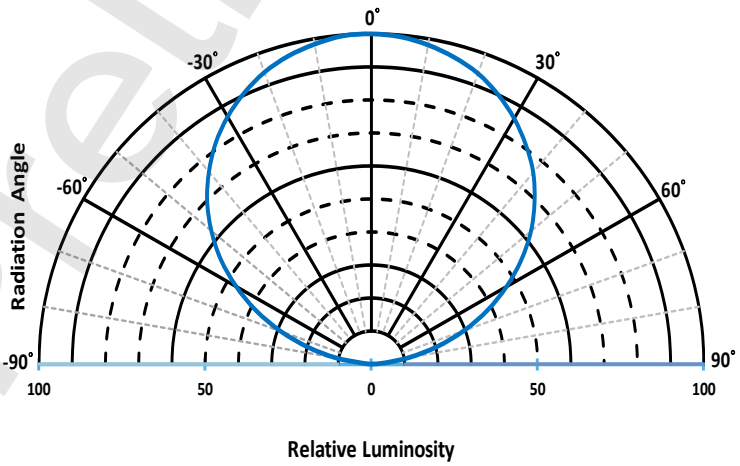
Figure 7: Typical Spatial Radiation Pattern at 150mA, T_{sp}=25°C



Notes for Figure 7:

1. Typical viewing angle is 120°.
2. The viewing angle is defined as the off axis angle from the centerline where luminous intensity (Iv) is ½ of the peak value.

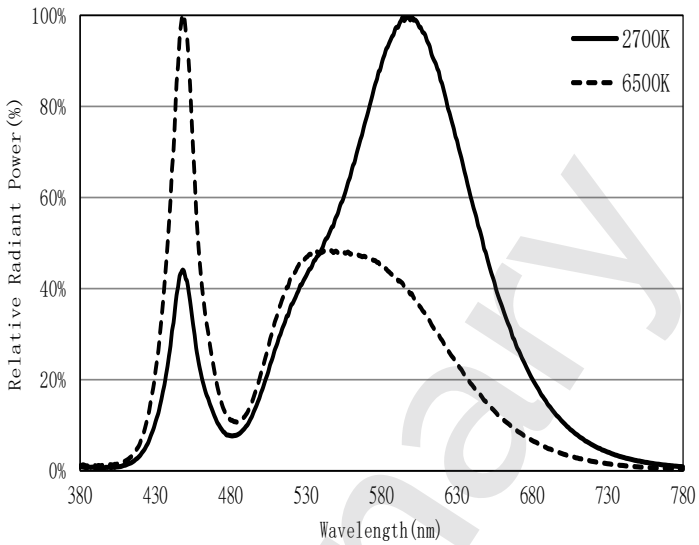
Figure 8: Typical Polar Radiation Pattern at 150mA, T_{sp}=25°C



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Typical Color Spectrum

Figure 9: Typical Color Spectrum



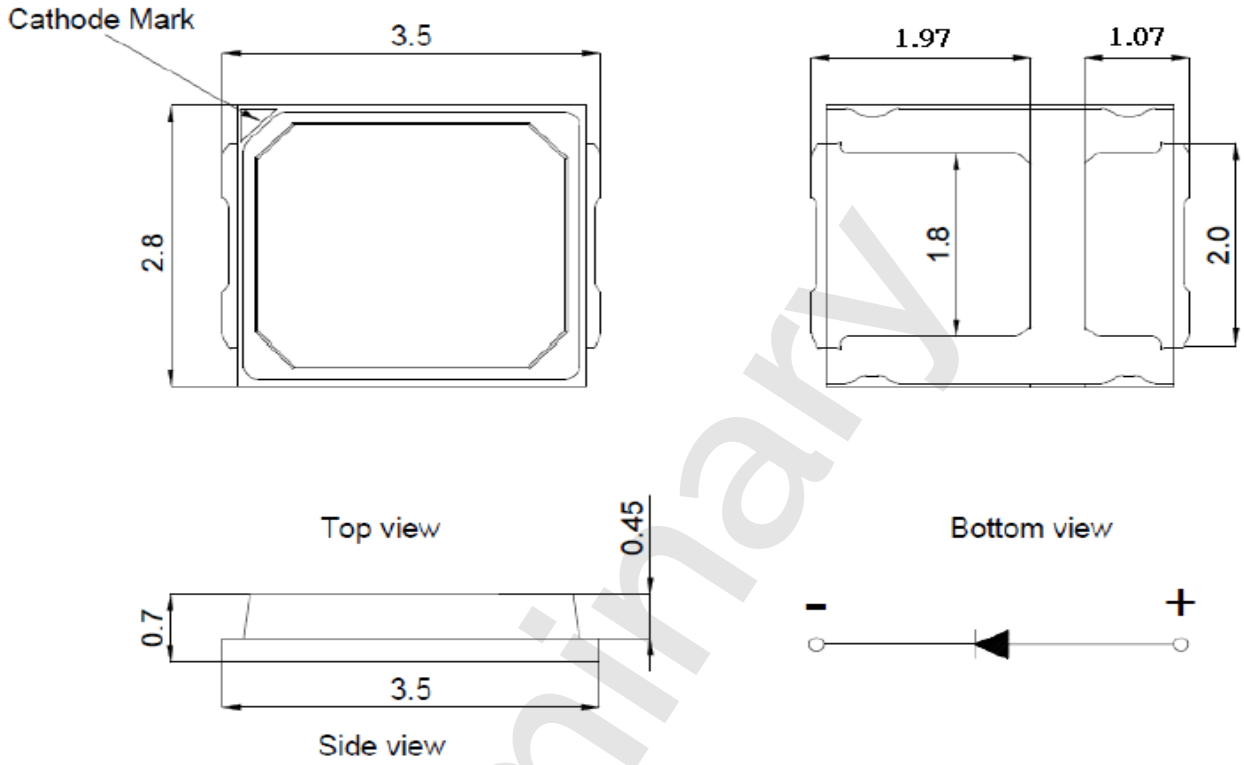
Notes for Figure 9:

1. Color spectra measured at nominal current for Tsp = 25°C
2. Color spectra shown for 70 CRI products.

Preliminary

Mechanical Dimensions

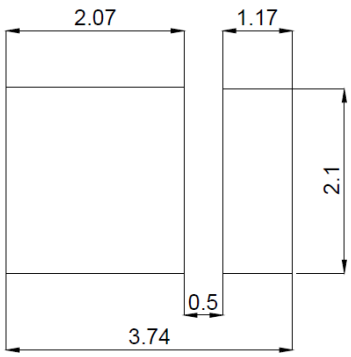
Figure 10: Drawing for SMD 2835



Notes for Figure 10:

1. Drawings are not to scale.
2. Drawing dimensions are in millimeters.
3. Unless otherwise specified, tolerances are ± 0.10mm.

Recommended PCB Soldering Pad Pattern



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Reliability

Table 8: Reliability Test Items and Conditions

No .	Items	Reference Standard	Test Conditions	Drive Current	Test Duration	Units Failed/Tested
1	Moisture/Reflow Sensitivity	J-STD-020E	T_{sld} = 260°C, 10sec, Precondition: 60°C, 60%RH, 168hr	-	3 reflows	0/20
2	Low Temperature Storage	JESD22-A119	T_a=-40°C	-	1000 hours	0/20
3	High Temperature Storage	JESD22-A103D	T_a= 100°C	-	1000 hours	0/20
4	Low Temperature Operating Life	JESD22-A108D	T_a=-40°C	150mA	1000 hours	0/20
5	Temperature Humidity Operating Life	JESD22-A101C	T_{sp}=85°C, RH=85%	150mA	1000 hours	0/20
6	High Temperature Operating Life	JESD22-A108D	T_{sp}=105°C	150mA	1000 hours	0/20
7	Power switching	IEC62717:2014	T_{sp} = 105°C 30 sec on, 30 sec off	150mA	30000 cycles	0/20
8	Thermal Shock	JESD22-A106B	T_a=-40°C ~100°C; Dwell : 15min; Transfer: 10sec	-	200 cycles	0/20
9	Temperature Cycle	JESD22-A104E	T_a=-40°C ~100°C; Dwell at extreme temperature: 15min; Ramp rate < 105°C/min	-	200 cycles	0/20
10	Electrostatic Discharge	JS-001-2012	HBM, 2KV, 1.5kΩ, 100pF, Alternately positive or negative	-	-	0/20

Passing Criteria

Item	Symbol	Test Condition	Passing Criteria
Forward Voltage	Vf	150mA	ΔVf<10%
Luminous Flux	Fv	150mA	ΔFv<30%
Chromaticity Coordinates	(x, y)	150mA	Δu'v'<0.007

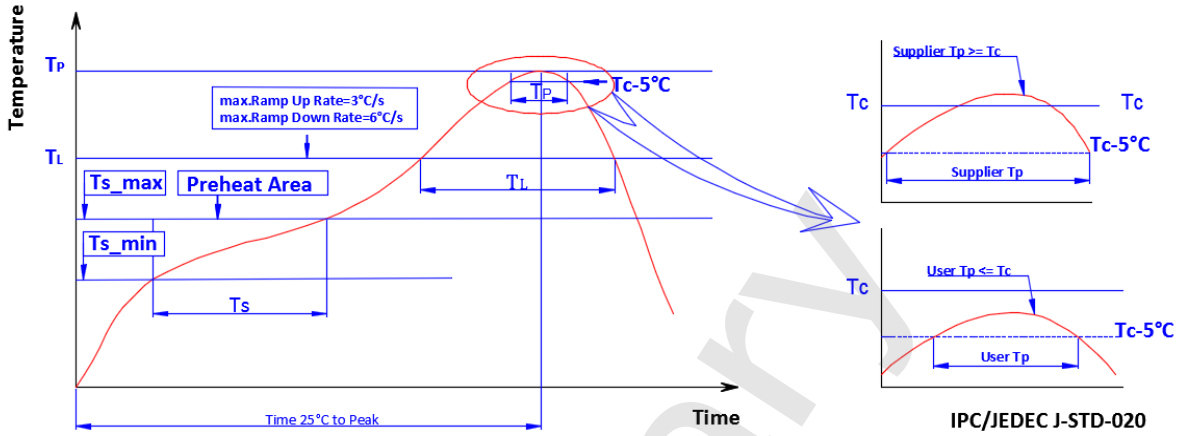
Notes for Table 8:

1. Measurements are performed after allowing the LEDs to return to room temperature
2. T_{sld} : reflow soldering temperature; T_a : ambient temperature

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Reflow Characteristics

Figure 11 : Reflow Profile (Reflow frequency 2 times max)

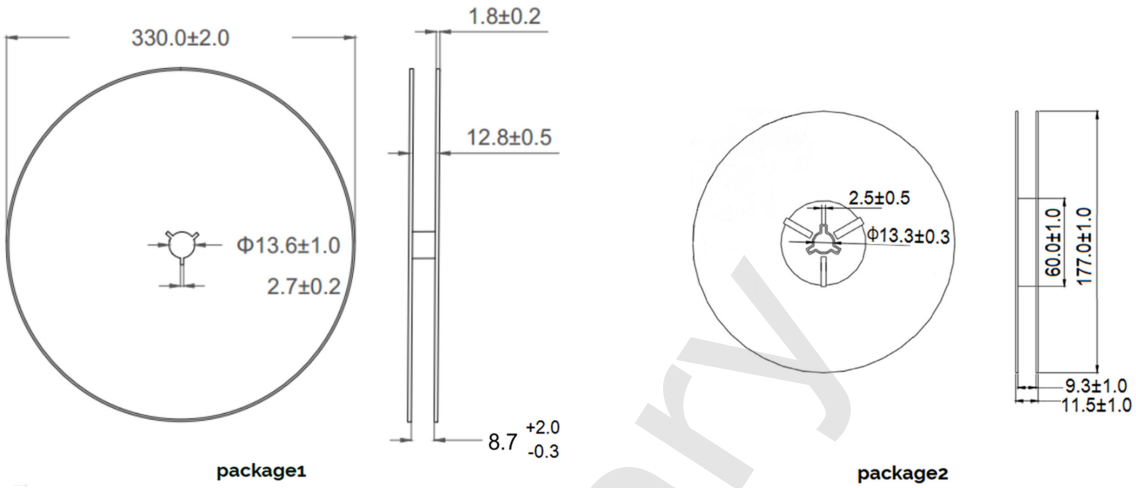


Profile Feature	Lead Free Assembly
Temperature Min. (Ts_min)	160˚C
Temperature Max. (Ts_max)	205˚C
Time (ts) from Ts_min to Ts_max	60-150 seconds
Ramp-Up Rate (TL to Tp)	3 ˚C/second
Liquidus Temperature (TL)	220 ˚C
Time (TL) Maintained Above TL	60-150 seconds
Peak Temp(Tp)	260 ˚C max 10 sec
Time (Tp) Within 5 ˚C of the Specified Classification Temperature (Tc)	25 seconds max.
Ramp-Down Rate (Tp to TL)	5 ˚C/second max.
Time 25 ˚C to Peak Temperature	10 minutes max.

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Packaging

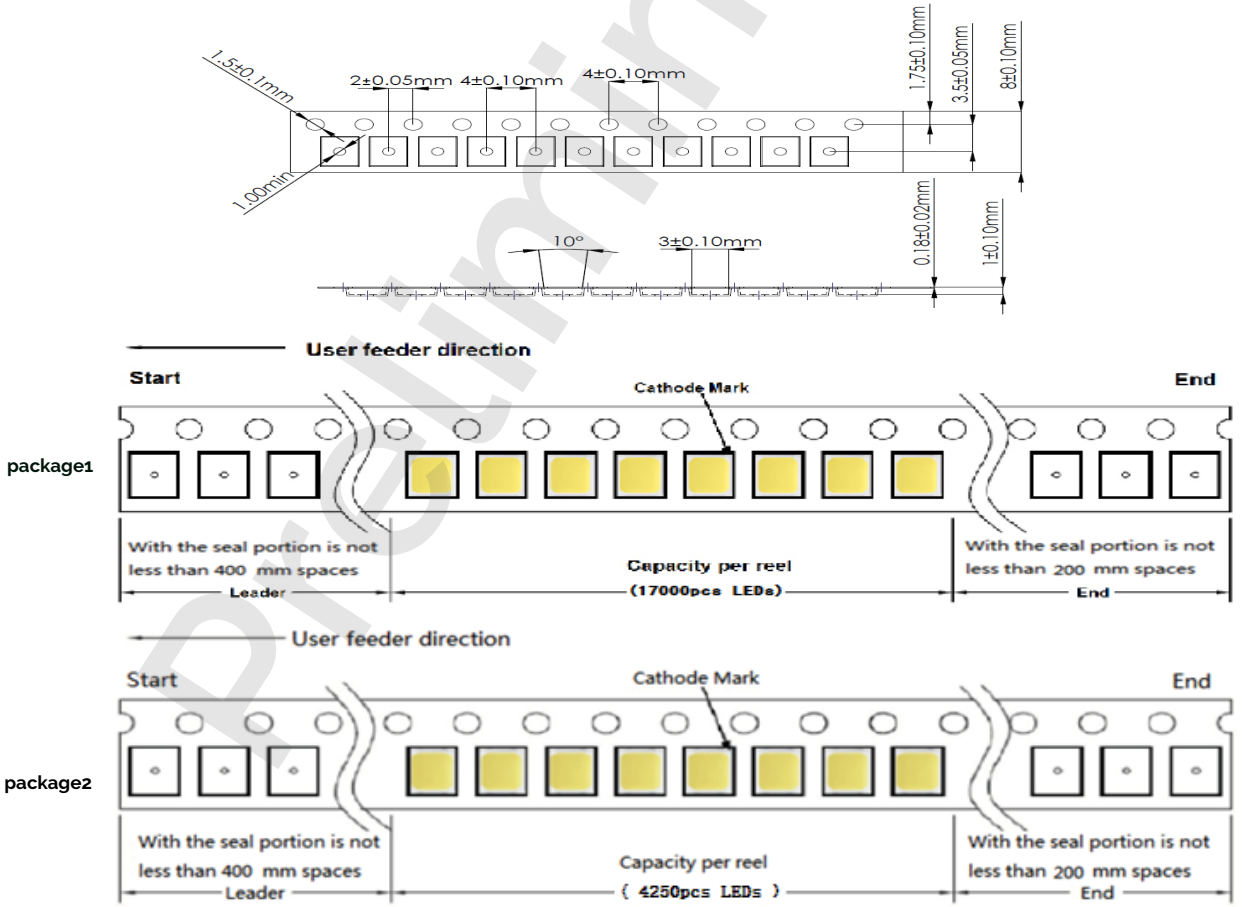
Figure 12: Emitter Reel Drawings



Note for Figure 12:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Figure 13: Emitter Tape Drawings



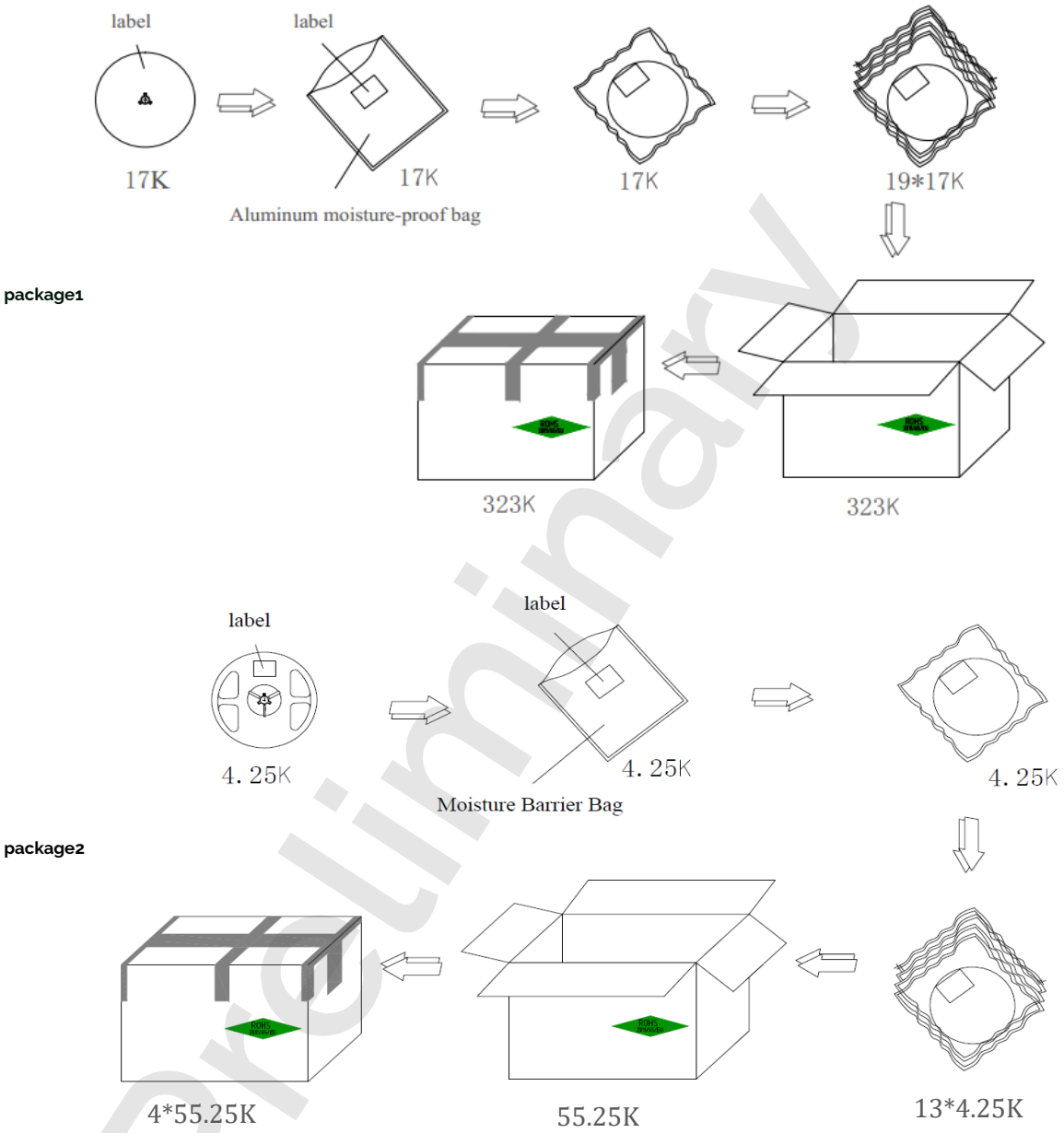
Note for Figure 13:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

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Packaging

Figure 14: Emitter Reel Packaging Drawings



Note for Figure 14:

1. Drawings are not to scale.

Preliminary

Design Resources

Please contact your Bridgelux sales representative for assistance.

Precautions

CAUTION: CHEMICAL EXPOSURE HAZARD

Exposure to some chemicals commonly used in luminaire manufacturing and assembly can cause damage to the LED emitter. Please consult Bridgelux Application Note AN51 for additional information.

CAUTION: EYE SAFETY

Eye safety classification for the use of Bridgelux SMD LED emitter is in accordance with IEC specification EN62471: Photobiological Safety of Lamps and Lamp Systems. This product can be classified as Risk Group 1 or lower when operated at or below the maximum drive current. Please use appropriate precautions. It is important that employees working with LEDs are trained to use them safely.

CAUTION: RISK OF BURN

Do not touch the SMD LED emitter during operation. Allow the emitter to cool for a sufficient period of time before handling. The SMD LED emitter may reach elevated temperatures such that could burn skin when touched.

CAUTION

CONTACT WITH LIGHT EMITTING SURFACE (LES)

Avoid any contact with the LES. Do not touch the LES of the emitter or apply stress to the LES (yellow phosphor resin area). Contact may cause damage to the emitter

Optics and reflectors must not be mounted in contact with the LES (yellow phosphor resin area).

Disclaimers

MINOR PRODUCT CHANGE POLICY

The rigorous qualification testing on products offered by Bridgelux provides performance assurance. Slight cosmetic changes that do not affect form, fit, or function may occur as Bridgelux continues product optimization.

STANDARD TEST CONDITIONS

Unless otherwise stated, LED emitter testing is performed at the nominal drive current.

Preliminary

About Bridgelux: Bridging Light and Life™

At Bridgelux, we help companies, industries and people experience the power and possibility of light. Since 2002, we've designed LED solutions that are high performing, energy efficient, cost effective and easy to integrate. Our focus is on light's impact on human behavior, delivering products that create better environments, experiences and returns—both experiential and financial. And our patented technology drives new platforms for commercial and industrial luminaires.

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